

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Zener Diode

DZ3J056D0L

Panasonic

DZ3J056D0L

Silicon epitaxial planar type

For surge absorption circuit DZ3X056D in SMini3 type package

■ Features

- · Excellent rising characteristics of zener current Iz
- Low zener operating resistance Rz
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol:0W

Packaging

Embossed type (Thermo-compression sealing) 3 000 pcs / reel (standard)

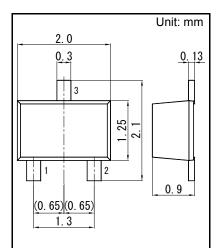
■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit				
Total power dissipation *1	PT	150	mW				
Electrostatic discharge *2	ESD	±10	kV				
Junction temperature	Tj	150	°C				
Operating ambient temperature	Topr	-40 to +85	°C				
Storage temperature	Tstg	-55 to +150	°C				

Note) *1: Mounted on glass epoxy print board. (45 mm x 45 mm x 1 mm) (2 Diode total)

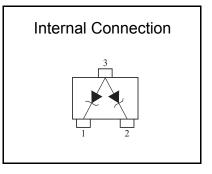
Solder in (0.9 mm x 0.8 mm)

*2: Test method:IEC61000_4_2(C = 150 pF,R = 330 Ω , Contact discharge:10 times)



- 1. Cathode1
- 2. Cathode2
- 3. Anode1,2

Panasonic	SMini3-F2-B
JEITA	SC-85
Code	_



■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage *1, *2	VZ	IZ = 5 mA	5.32		5.88	V
Zener operating resistance	RZ	IZ = 5 mA			40	Ω
Zener rise operating resistance	RZK	IZ = 0.5 mA			200	Ω
Reverse current	IR	VR = 2.5 V			0.5	μA
Temperature coefficient of zener voltage *3	SZ	IZ = 5 mA		2.0		mV/°C

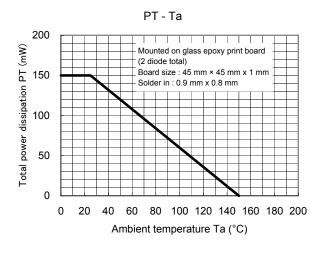
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - *1: The temperature must be controlled 25°C for VZ mesurement.
 VZ value measured at other temperature must be adjusted to VZ (25°C)
 - *2: VZ guaranted 20 ms after current flow.
 - *3: Tj = 25°C to 150°C

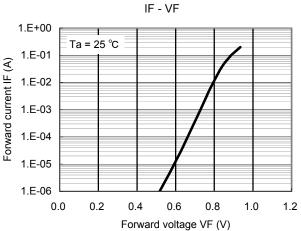
Established : 2012-06-14 Revised : 2013-11-01

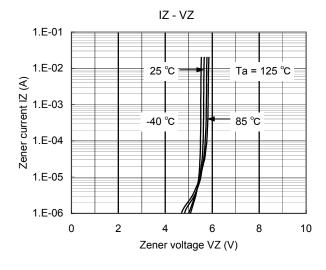
Zener Diode

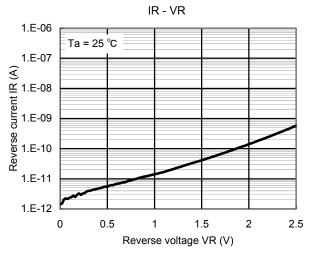
DZ3J056D0L

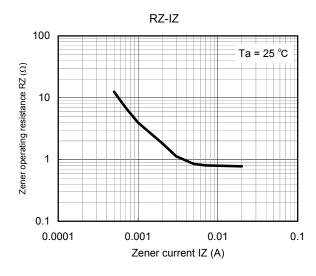
Technical Data (reference)

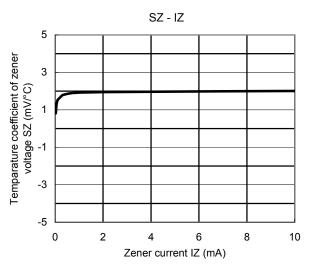










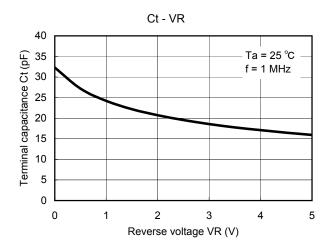


Established: 2012-06-14 Revised: 2013-11-01 **Panasonic**

Zener Diode

DZ3J056D0L

Technical Data (reference)



Established: 2012-06-14 Revised: 2013-11-01

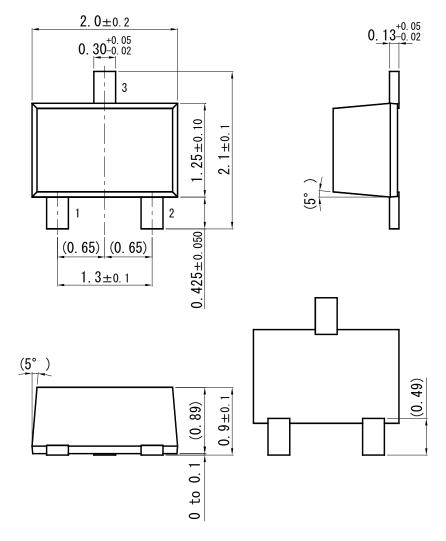
Zener Diode

DZ3J056D0L

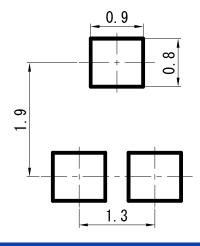
Panasonic

SMini3-F2-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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